

ABSTRACT

A negative radiation-sensitive two-layer laminated film for forming bumps includes a lower layer that includes a composition including a polymer (A) with a specific structural unit and an organic solvent (B). A process for forming bumps
5 uses the laminated film.

The negative radiation-sensitive two-layer laminated film for forming bumps permits excellent printing of a solder paste, is patternable with good configuration, and is easily
10 peeled from a substrate. The bump-forming process using the laminated film provides the same effects.